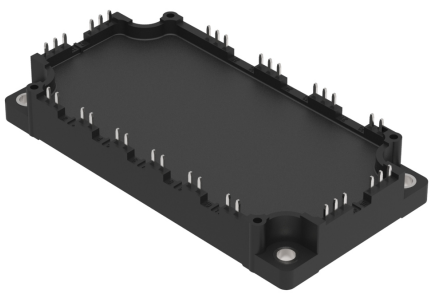
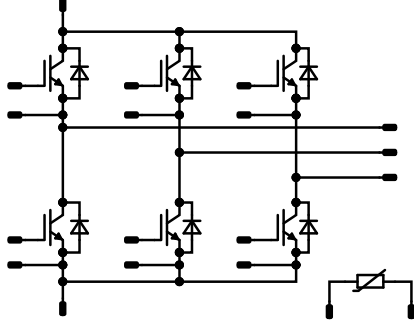




VINcoPACK E3	1200 V / 200 A
<p data-bbox="375 448 478 470">Features</p> <ul data-bbox="135 504 598 627" style="list-style-type: none">• IGBT Mitsubishi gen 7 technology with low VCesat and improved EMC behavior• New SoLid Cover Technology for higher reliability• Industry standard housing• Press-fit pin and pre-applied phase-change Thermal Interface Material available	<p data-bbox="997 448 1292 470">VINco E3 17 mm housing</p> 
<p data-bbox="311 974 542 996">Target applications</p> <ul data-bbox="135 1019 303 1041" style="list-style-type: none">• Industrial Drives	<p data-bbox="1085 940 1212 963">Schematic</p> 
<p data-bbox="391 1108 462 1131">Types</p> <ul data-bbox="135 1153 406 1176" style="list-style-type: none">• A0-VS126PA200M7-L999F70	



Vincotech

A0-VS126PA200M7-L999F70
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	173	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	318	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	9,5	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	137	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	235	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^{\circ}\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V'_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			9	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,02	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		200	25 125 150		1,69 1,88 1,93	1,85 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			100	μA
Gate-emitter leakage current	I_{GES}		20	0		25			500	nA
Internal gate resistance	r_g							2		Ω
Input capacitance	C_{ies}							37000		pF
Output capacitance	C_{oes}		0	10		25		1100		pF
Reverse transfer capacitance	C_{res}							420		pF
Gate charge	Q_g	$V_{CC} = 600$ V	15		200	25		1200		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,3		K/W
--	---------------	---------------------------------------	--	--	--	--	--	-----	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		283,2 300 305,6		ns
Rise time	t_r					25 125 150		47,4 58,6 61		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		232,8 263,4 273,2		ns
Fall time	t_f					25 125 150		76,7 94,25 96,24		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 21,43$ μC $Q_{tFWD} = 31,96$ μC $Q_{tFWD} = 36,25$ μC				25 125 150		16,28 22,83 25,08		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		13,25 17,54 18,99		mWs



Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Inverter Diode										
Static										
Forward voltage	V_F				200	25 125 150		1,86 1,99 1,98	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25			40	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,4		K/W
Dynamic										
Peak recovery current	I_{RRM}					25 125 150		166,92 163,7 164,58		A
Reverse recovery time	t_{rr}					25 125 150		309,66 479,84 520,58		ns
Recovered charge	Q_r	$di/dt=4313$ A/μs $di/dt=4301$ A/μs $di/dt=3318$ A/μs	±15	600	200	25 125 150		21,43 31,96 36,25		μC
Reverse recovered energy	E_{rec}					25 125 150		8,05 12,25 13,92		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		1395 924,44 854,82		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_{CE} [V]	T_j [°C]	Min	Typ	Max	

Thermistor

Static

Rated resistance	R					25		5		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 493 \Omega$				100	-5		5	%
Power dissipation	P							245		mW
Power dissipation constant	d					25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 2 \%$						3375		K
B-value	$B_{(25/100)}$	Tol. $\pm 2 \%$						3437		K
Vincotech Thermistor Reference									K	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

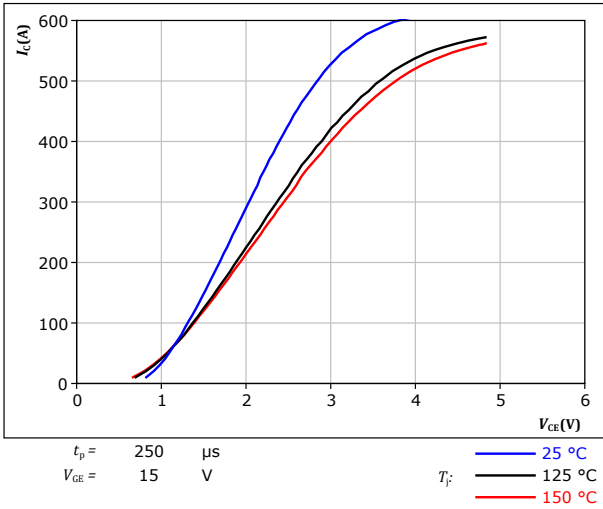


figure 2. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

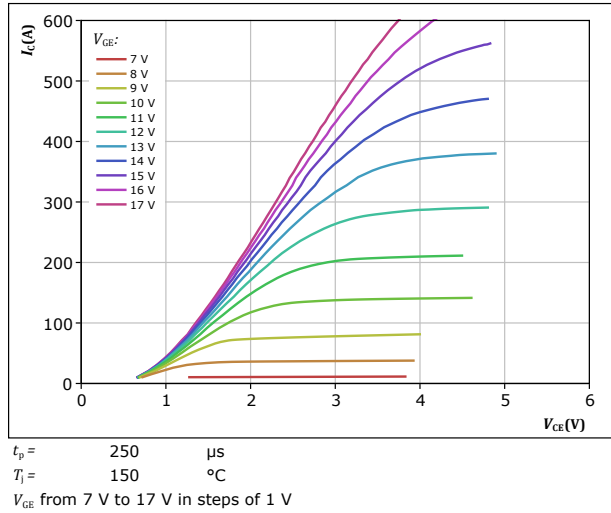


figure 3. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

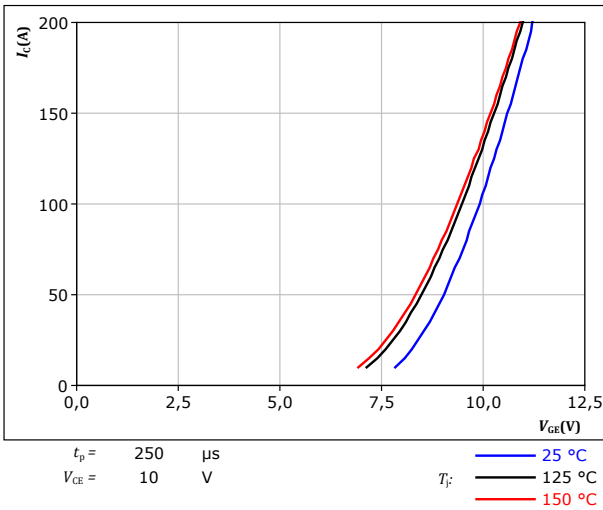
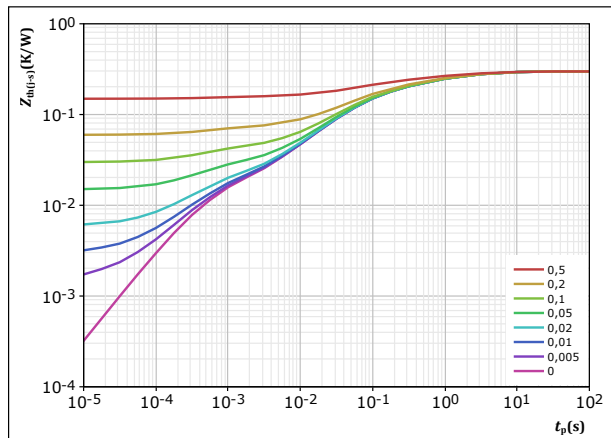


figure 4. IGBT

Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 0,298 \text{ K/W}$

IGBT thermal model values

R (K/W)	τ (s)
2,88E-02	5,48E+00
6,08E-02	1,14E+00
8,17E-02	2,27E-01
9,49E-02	4,76E-02
1,90E-02	1,06E-02
1,33E-02	4,72E-04



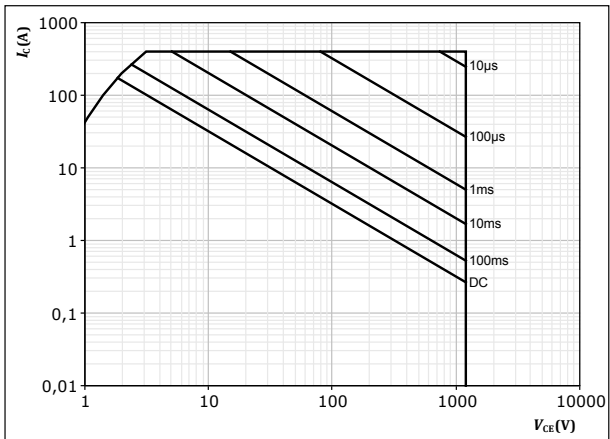
Vincotech

Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{GE} = 15$ V

$T_j = T_{jmax}$



Inverter Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

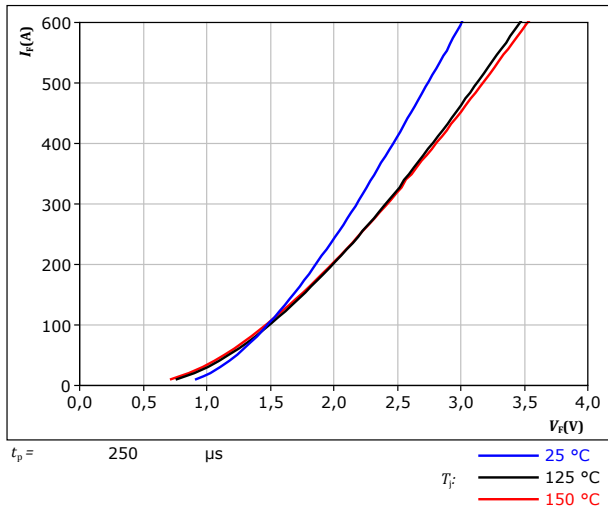
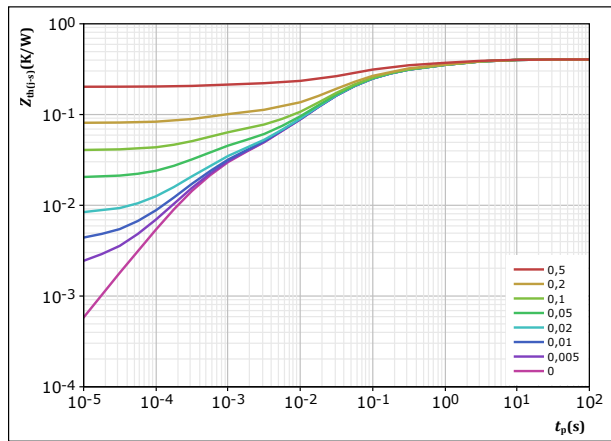


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 0,405 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
2,18E-02	6,58E+00
7,39E-02	1,24E+00
1,19E-01	1,47E-01
1,51E-01	3,00E-02
1,42E-02	4,40E-03
2,45E-02	4,95E-04

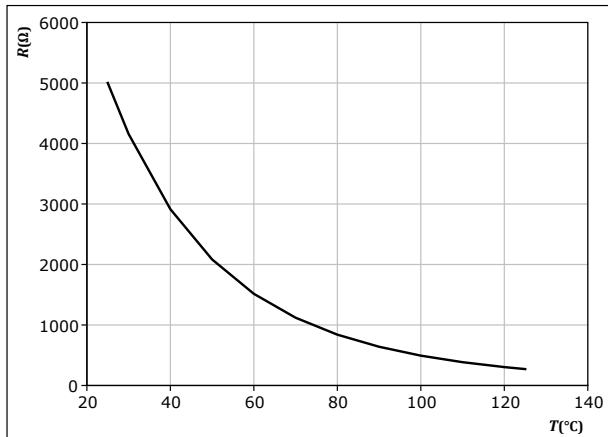


Thermistor Characteristics

figure 8. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

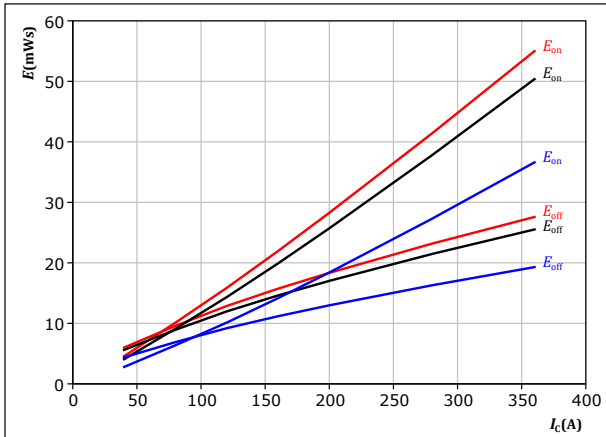




Inverter Switching Characteristics

figure 9. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

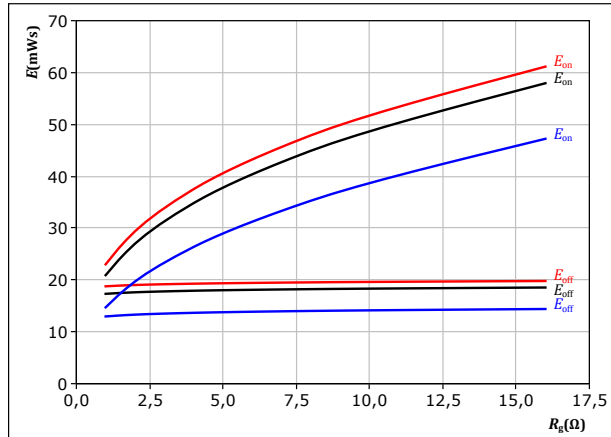


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$R_{g(on)} =$	1	Ω		—	150 °C
$R_{g(off)} =$	1	Ω			

figure 10. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

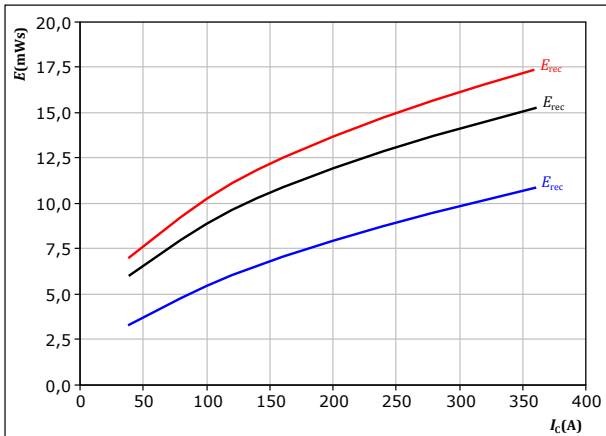


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$I_c =$	200	A		—	150 °C

figure 11. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

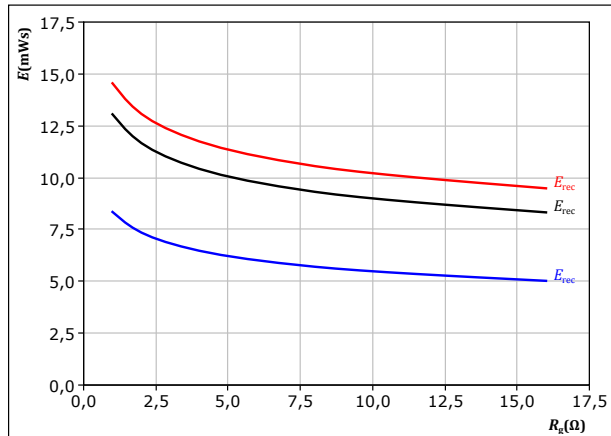


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$R_{g(on)} =$	1	Ω		—	150 °C

figure 12. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

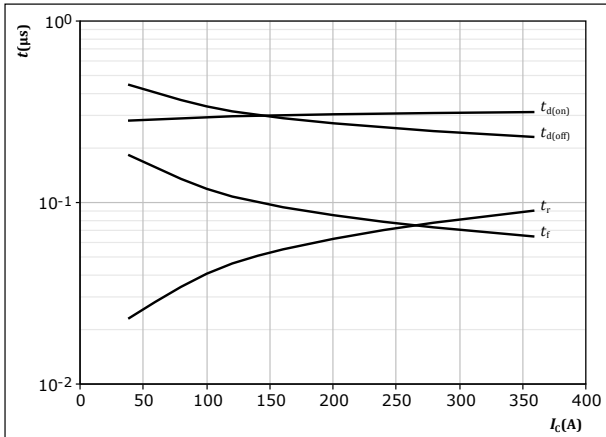
$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$I_c =$	200	A		—	150 °C



Inverter Switching Characteristics

figure 13. IGBT

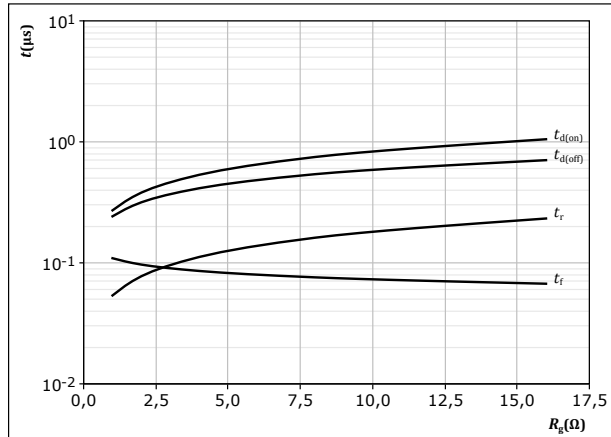
Typical switching times as a function of collector current
 $t = f(I_C)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 1 \text{ } \Omega$
 $R_{goff} = 1 \text{ } \Omega$

figure 14. IGBT

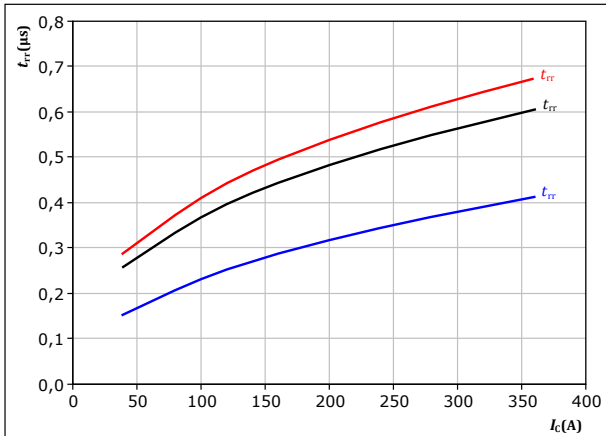
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 200 \text{ A}$

figure 15. FWD

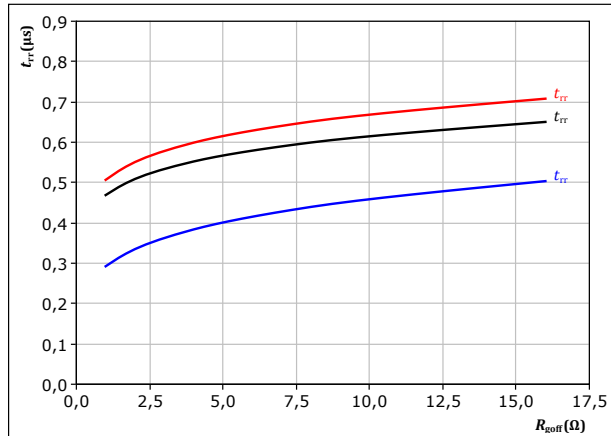
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 1 \text{ } \Omega$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 16. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at
 $V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 200 \text{ A}$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

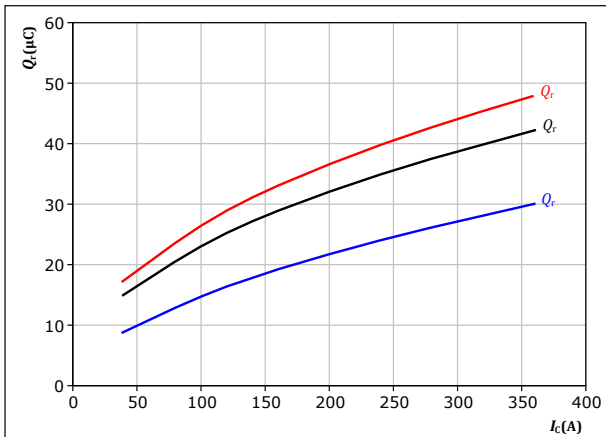


Inverter Switching Characteristics

figure 17. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

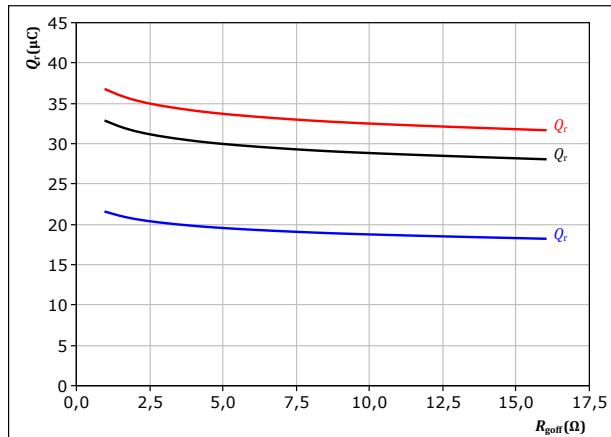
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{goff} = 1 \ \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 18. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

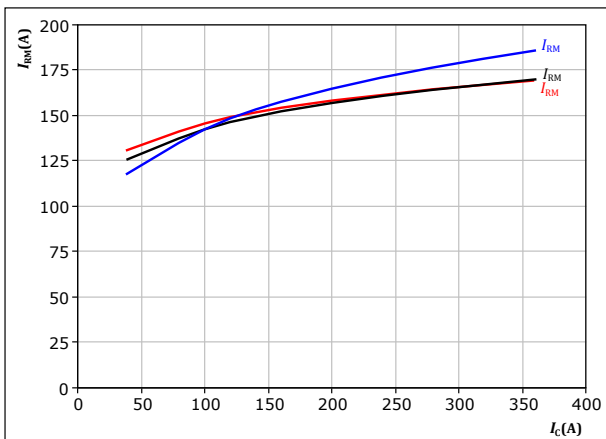
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 200 \text{ A}$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 19. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

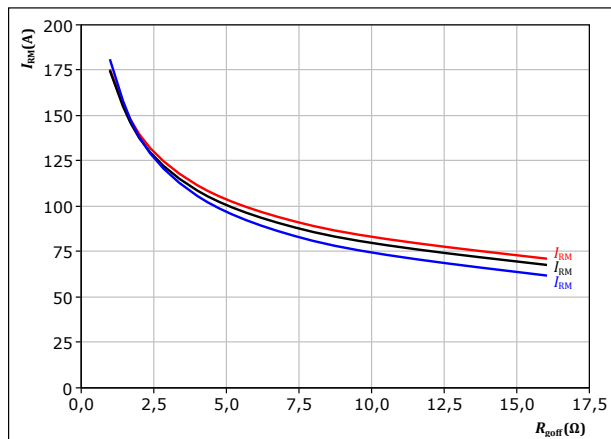
$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{goff} = 1 \ \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 20. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 200 \text{ A}$

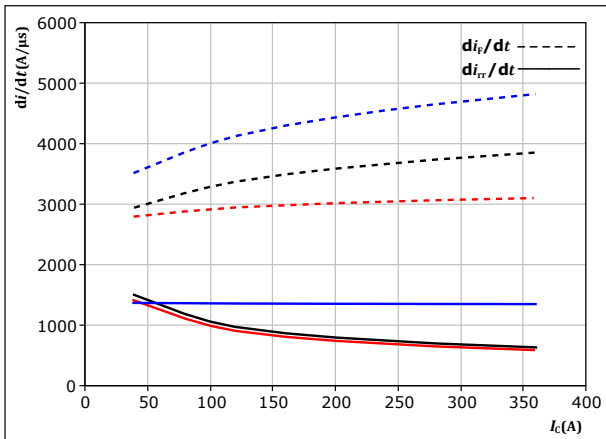
T_j : — 25 °C
— 125 °C
— 150 °C



Inverter Switching Characteristics

figure 21. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_C)$

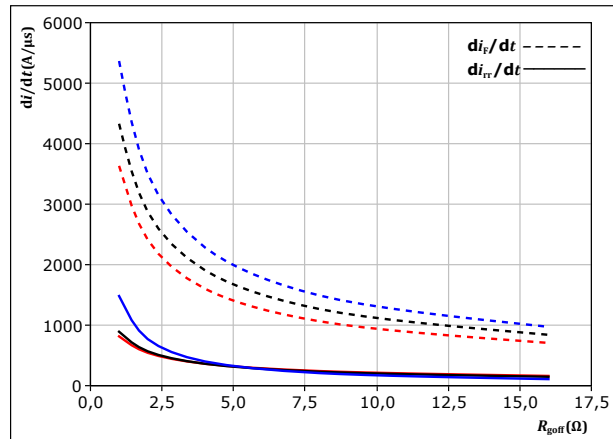


With an inductive load at

$V_{CE} =$	600	V	$T_f =$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{goff} =$	1	Ω		150 °C

figure 22. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



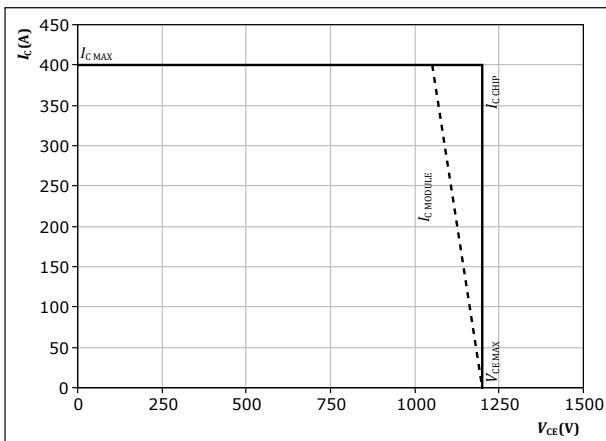
With an inductive load at

$V_{CE} =$	600	V	$T_f =$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_C =$	200	A		150 °C

figure 23. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

$T_f =$	150	°C
$R_{goff} =$	1	Ω
$R_{goff} =$	1	Ω



Inverter Switching Definitions

figure 24. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

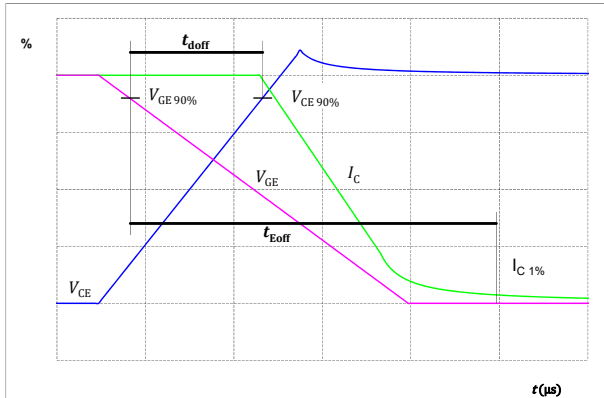


figure 25. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

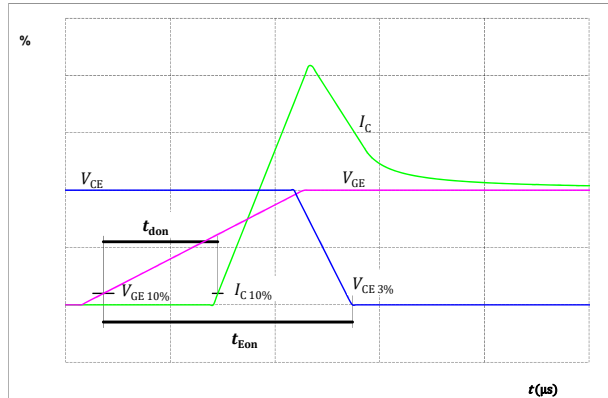


figure 26. IGBT

Turn-off Switching Waveforms & definition of t_f

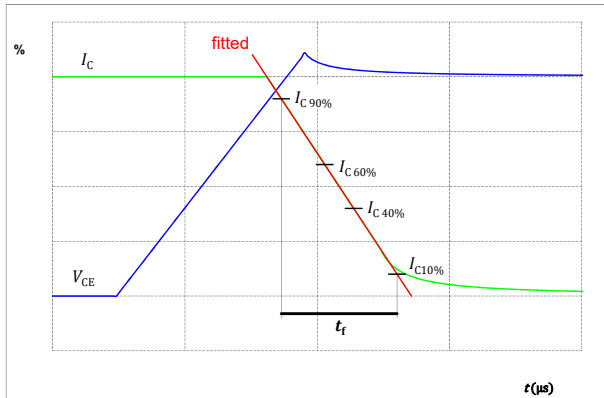
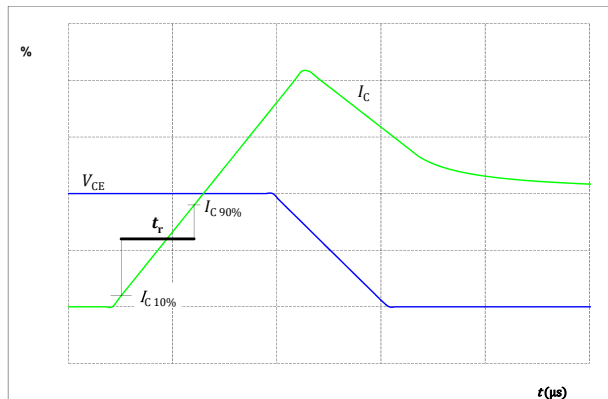


figure 27. IGBT

Turn-on Switching Waveforms & definition of t_r





Inverter Switching Definitions

figure 28. FWD

Turn-off Switching Waveforms & definition of t_{rr}

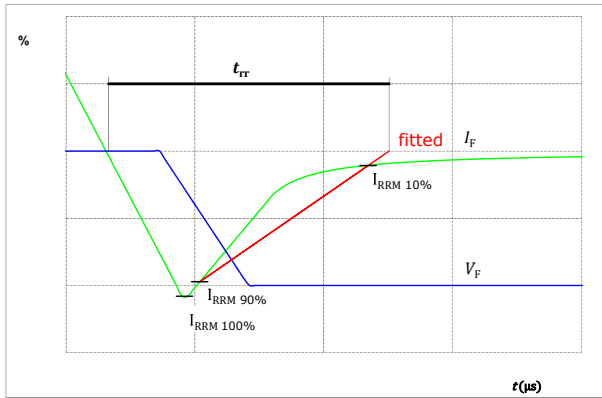
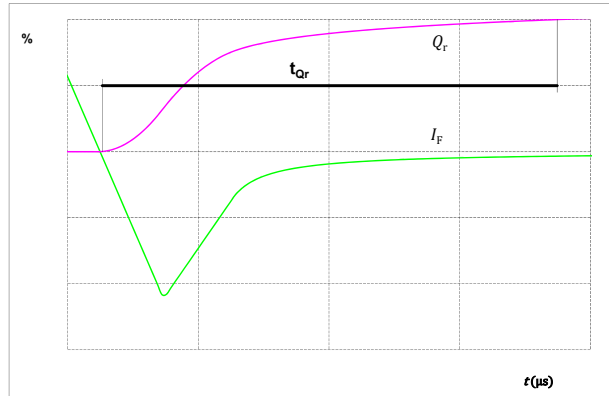


figure 29. FWD


Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)



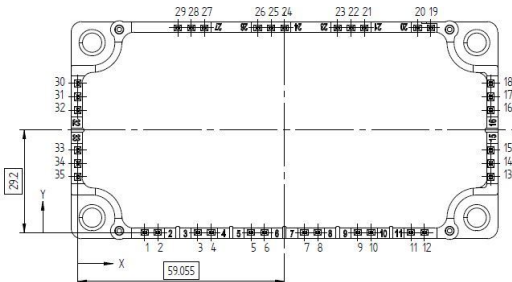


Vincotech

Ordering Code	
Version	Ordering Code
Without thermal paste	A0-VS126PA200M7-L999F70
With thermal paste (3,4 W/mK, PSX-P7)	A0-VS126PA200M7-L999F70-/3/

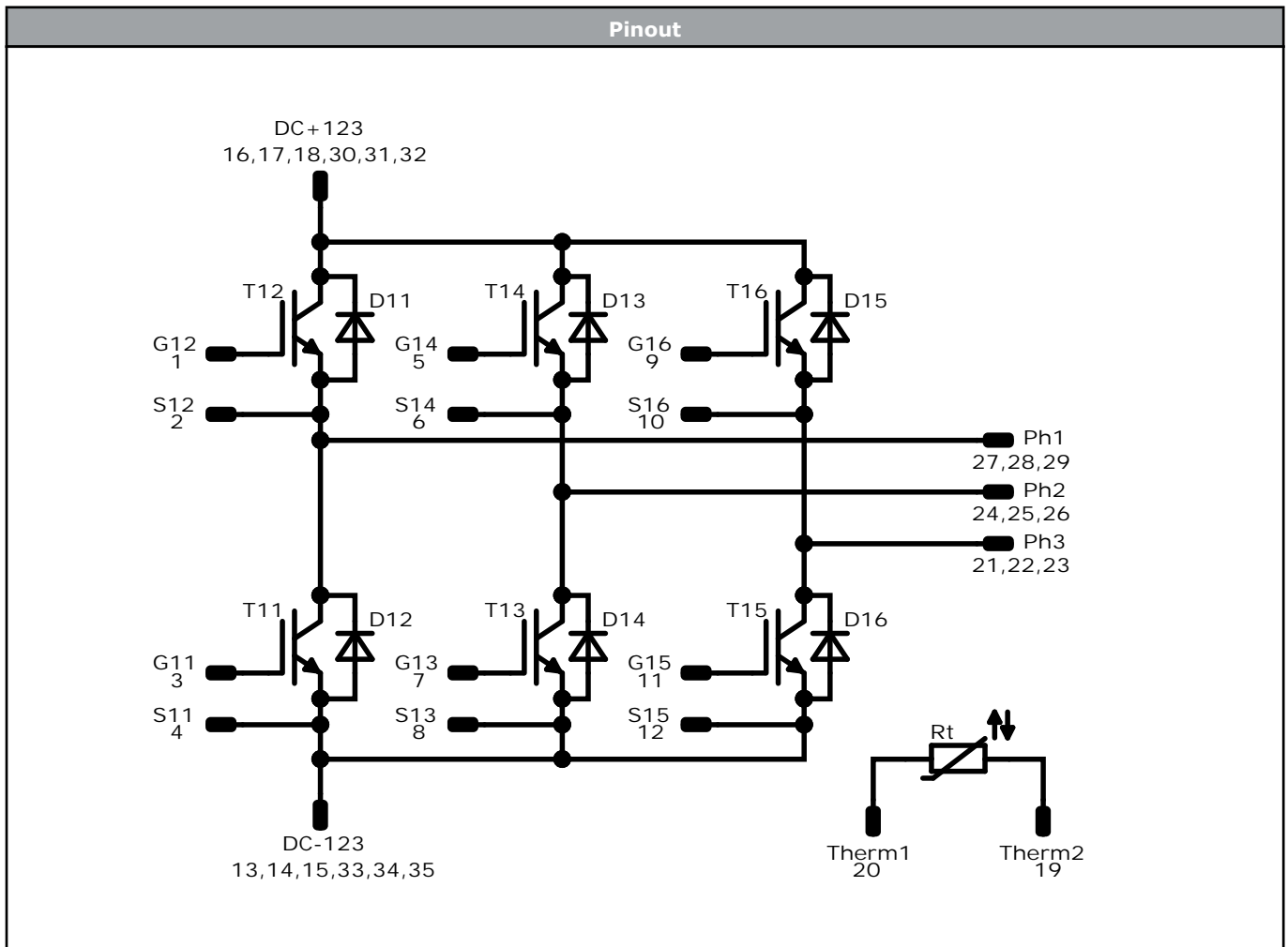
Marking						
 <small>NN-NNNNNNNNNN-TTTTTTVV VIN WWYY LLLLL SSSS</small>	Text	Name NN-NNNNNNNNNNNNNNNN- TTTTTVV	VIN VIN	Date code WWYY	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	

Outline				
Pin table [mm]				
Pin	X	Y	Function	
1	19,05	0	G12	
2	22,86	0	S12	
3	34,29	0	G11	
4	38,1	0	S11	
5	49,53	0	G14	
6	53,34	0	S14	
7	64,77	0	G13	
8	68,58	0	S13	
9	80,01	0	G16	
10	83,82	0	S16	
11	95,25	0	G15	
12	99,06	0	S15	
13	118,11	15,865	DC-123	
14	118,11	19,675	DC-123	
15	118,11	23,485	DC-123	
16	118,11	34,915	DC+123	
17	118,11	38,725	DC+123	
18	118,11	42,535	DC+123	
19	100,965	58,4	Therm1	
20	97,155	58,4	Therm2	
21	81,915	58,4	Ph3	
22	78,105	58,4	Ph3	
23	74,295	58,4	Ph3	
24	59,055	58,4	Ph2	
25	55,245	58,4	Ph2	
26	51,435	58,4	Ph2	
27	36,195	58,4	Ph1	
28	32,385	58,4	Ph1	
29	28,575	58,4	Ph1	
30	0	42,535	DC+123	
31	0	38,725	DC+123	
32	0	34,915	DC+123	
33	0	23,485	DC-123	
34	0	19,675	DC-123	
35	0	15,865	DC-123	





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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	200 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	200 A	Inverter Diode	
Rt	NTC			Thermistor	




Packaging instruction				
Standard packaging quantity (SPQ) 24	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for VINco E3 packages see vincotech.com website.

Package data
Package data for VINco E3 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
A0-VS126PA200M7-L999F70-D2-14	26 Sep. 2021	Thermal characteristics are updated Separated datasheet for solder pin version New datasheet format, module is unchanged	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.